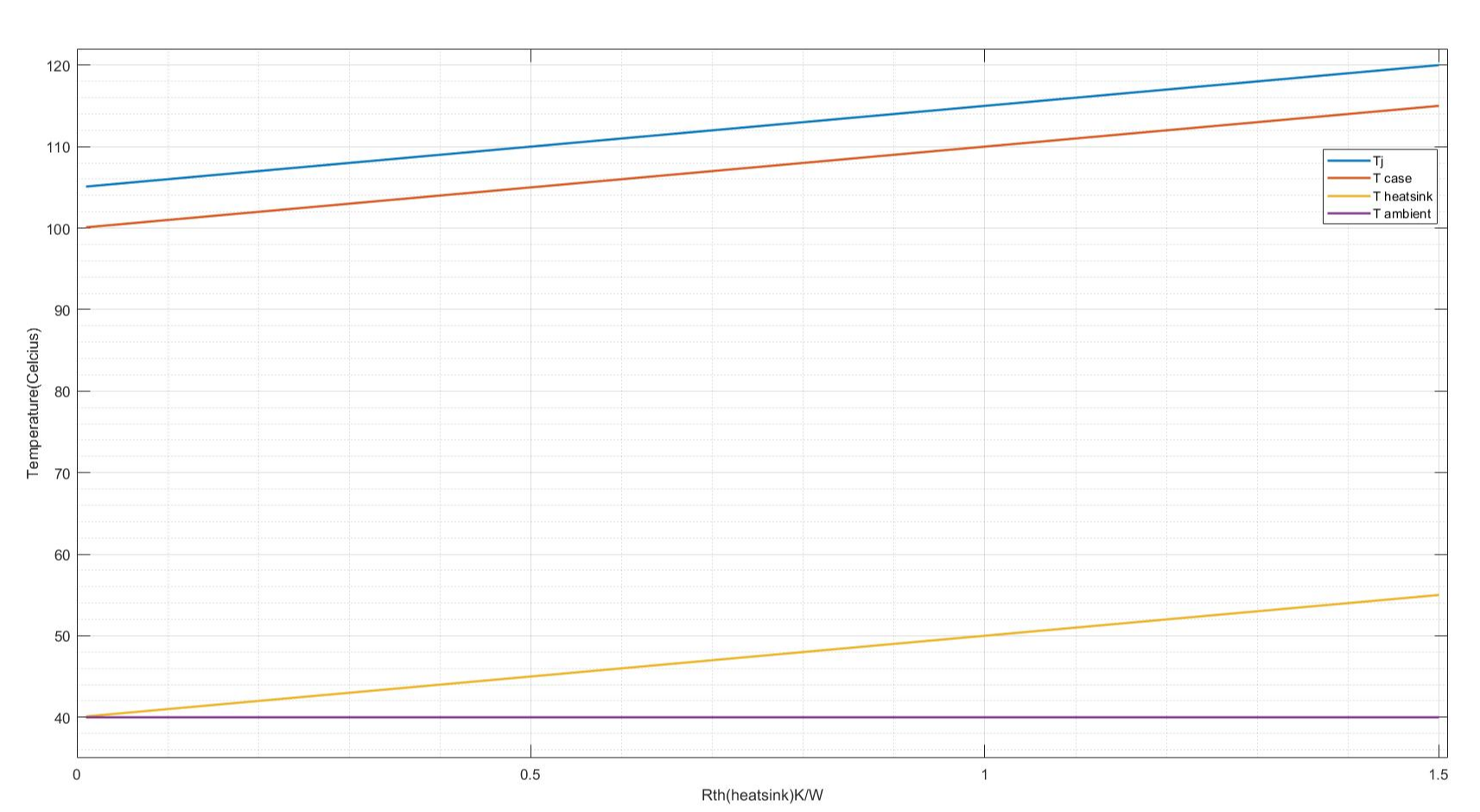


* 123 Thermal via (0.3mm diameter) , 6 Layer PCB, Rjc= 0.5 Ω , Rcpb= 4.5Ω(1.6mm & 6 layer), RTIM = 1.5 Ω



If you think that GanFET is a black box with 0.5 Rjc ;

* L is the thickness (m) (thickness of the package and the thermal pad);
* A is the effective contact area (m2) (Area of the thermal pad) ;
* k is the conductivity of the box (W/(m\*K))

